

● General Description

Through advanced trench and field stop technology to provide very low  $V_{CE(sat)}$ , low gate charge, and excellent switching performance.

● Features

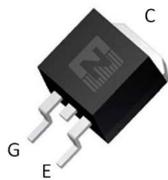
- Very low  $V_{CE(sat)}$
- Low switching power loss
- Low switching surge and noise
- Low thermal resistance
- AEC-Q101 qualified

● Application

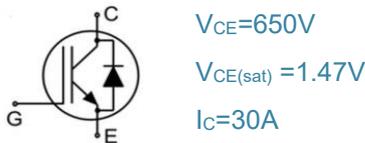
- Motor drives



● Product Summary



TO-263



● Ordering Information

Part NO.	ZMBGA30N065TD1AB
Marking	BG30N065TD1A
Packing information	REEL TAPE
Basic ordering unit (pcs)	800

● Absolute Maximum Ratings ( $T_A=25^{\circ}C$ , unless otherwise specified)

Parameter	Symbol	Conditions	Min.	Max.	Unit
Collector-emitter voltage	$V_{CE}$		-	650	V
Gate-emitter voltage <sup>①</sup>	$V_{GE}$		-20	20	V
Continuous collector current	$I_C$	$V_{GE}=15V, T_C=25^{\circ}C$	-	60	A
	$I_C$	$V_{GE}=15V, T_C=100^{\circ}C$	-	30	A
Pulsed collector current <sup>①</sup>	$I_{CM}$	Pulsed; $t_p \leq 10 \mu s; T_C = 25^{\circ}C$	-	120	A
Diode forward current	$I_F$	$V_{GE}=0V, T_C=25^{\circ}C$	-	60	A
		$V_{GE}=0V, T_C=100^{\circ}C$	-	30	A
Pulsed diode forward current	$I_{F,pulse}$	Pulsed; $t_p \leq 10 \mu s; T_C = 25^{\circ}C$	-	120	A
Total power dissipation	$P_D$	$T_C=25^{\circ}C$	-	417	W
Total power dissipation	$P_D$	$T_A=25^{\circ}C$	-	3.8	W
Operating junction temperature	$T_J$		-55	175	$^{\circ}C$
Storage temperature	$T_{STG}$		-55	175	$^{\circ}C$

## ● Thermal resistance

Parameter	Symbol	Min.	Typ.	Max.	Unit
Thermal resistance, junction - case IGBT	$R_{thJC}$	-	-	0.36	°C/W
Thermal resistance, junction - case diode	$R_{thJC}$	-	-	0.88	°C/W
Thermal resistance, junction - ambient	$R_{thJA}^{\textcircled{2}}$	-	-	40	°C/W
Soldering temperature (total time<10s)	$T_{\text{sold}}$	-	-	260	°C

 ● Electronic Characteristics ( $T_j=25^{\circ}\text{C}$ , unless otherwise specified)

Parameter	Symbol	Condition	Min.	Typ.	Max.	Unit
Collector-emitter breakdown voltage	$BV_{CES}$	$V_{GE}=0V, I_C=250\mu A$	650	-	-	V
Gate-emitter threshold voltage	$V_{GE(th)}$	$V_{GE}=V_{CE}, I_C=1mA$	4	5.3	6	V
Zero gate voltage collector current	$I_{CES}$	$V_{GE}=0V, V_{CE}=650V, T_j=25^{\circ}\text{C}$	-	-	10	$\mu A$
		$V_{GE}=0V, V_{CE}=650V, T_j=175^{\circ}\text{C}$	-	-	10	mA
Gate-emitter leakage current	$I_{GES}$	$V_{GE}=\pm 20V, V_{CE}=0V$	-	-	100	nA
Collector-emitter saturation voltage	$V_{CE(sat)}$	$V_{GE}=15V, I_C=30A, T_j=25^{\circ}\text{C}$	-	1.47	1.75	V
		$V_{GE}=15V, I_D=30A, T_j=175^{\circ}\text{C}$	-	1.87	-	V
Forward transconductance	$g_{FS}$	$V_{CE}=20V, I_C=30A$	-	22	-	S
Diode forward voltage	$V_F$	$I_F=30A, T_C=25^{\circ}\text{C}$	-	1.4	1.8	V
		$I_F=30A, T_C=175^{\circ}\text{C}$	-	1.1	1.5	V

 ● Dynamic characteristics ( $T_j=25^{\circ}\text{C}$ , unless otherwise specified)

Parameter	Symbol	Condition	Min.	Typ.	Max.	Unit
Input capacitance	$C_{ies}$	$f=100\text{KHz}, V_{CE}=400V, V_{GE}=0V$	-	2521	-	pF
Output capacitance	$C_{oes}$		-	44	-	pF
Reverse transfer capacitance	$C_{res}$		-	6.5	-	pF
Gate resistance	$R_g$	$f=1\text{MHz}$	-	1.6	-	$\Omega$
Total gate charge	$Q_g$	$V_{CC}=400V, I_C=30A, V_{GE}=15V$	-	78.4	-	nC
Gate-emitter charge	$Q_{ge}$		-	20.5	-	nC
Gate-collector charge	$Q_{gc}$		-	29.3	-	nC

● Switching characteristics ( $T_j=25^\circ\text{C}$ )

Parameter	Symbol	Condition	Min.	Typ.	Max.	Unit
Turn-on delay time	$t_{d(on)}$	$T_j=25^\circ\text{C}$ $V_{GE}=15/-15\text{V}$ , $V_{CE}=400\text{V}$ , $R_G=10\Omega$ , $I_C=30\text{A}$ , $L=105\mu\text{H}$	-	20	-	ns
Turn-on rise time	$t_r$		-	20	-	ns
Turn-off delay time	$t_{d(off)}$		-	70	-	ns
Turn-off fall time	$t_f$		-	65	-	ns
Turn-on energy	$E_{on}$		-	0.95	-	mJ
Turn-off energy	$E_{off}$		-	0.48	-	mJ
Total switching energy	$E_{ts}$		-	1.43	-	mJ

 ● Switching characteristics ( $T_j=150^\circ\text{C}$ )

Parameter	Symbol	Condition	Min.	Typ.	Max.	Unit
Turn-on delay time	$t_{d(on)}$	$T_j=150^\circ\text{C}$ $V_{GE}=15/-15\text{V}$ , $V_{CE}=400\text{V}$ , $R_G=10\Omega$ , $I_C=30\text{A}$ , $L=105\mu\text{H}$	-	19	-	ns
Turn-on rise time	$t_r$		-	18	-	ns
Turn-off delay time	$t_{d(off)}$		-	81	-	ns
Turn-off fall time	$t_f$		-	90	-	ns
Turn-on energy	$E_{on}$		-	1.03	-	mJ
Turn-off energy	$E_{off}$		-	0.63	-	mJ
Total switching energy	$E_{ts}$		-	1.66	-	mJ

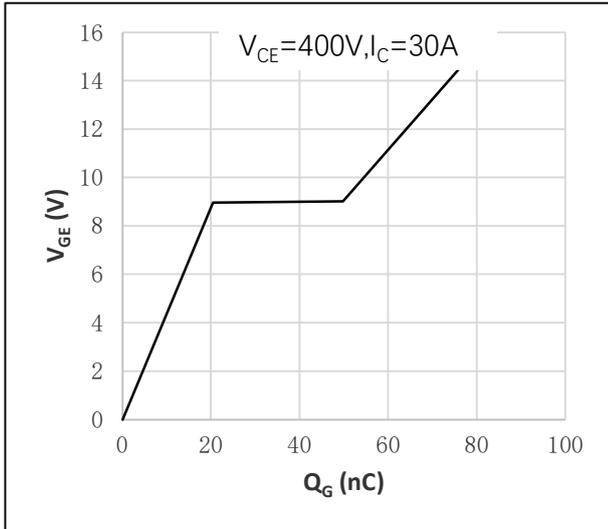
 ● Diode switching characteristics ( $T_j=25^\circ\text{C}$ )

Parameter	Symbol	Condition	Min.	Typ.	Max.	Unit
Reverse recovery time	$t_{rr}$	$T_j=25^\circ\text{C}$ $V_R=400\text{V}$ , $I_F=30\text{A}$ , $di_F/dt=1000\text{A}/\mu\text{s}$ ,	-	28	-	ns
Reverse recovery charge	$Q_{rr}$		-	189	-	nC
Reverse recovery	$I_{rrm}$		-	11.8	-	A
Reverse recovery energy	$E_{rr}$		-	78	-	$\mu\text{J}$

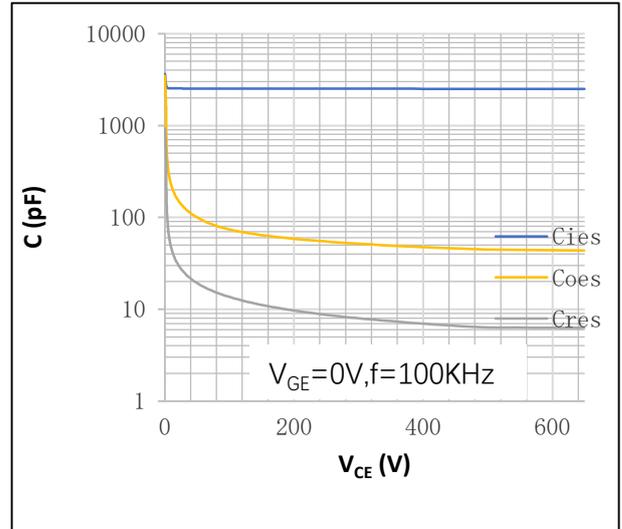
 ● Switching characteristics ( $T_j=150^\circ\text{C}$ )

Parameter	Symbol	Condition	Min.	Typ.	Max.	Unit
Reverse recovery time	$t_{rr}$	$T_j=150^\circ\text{C}$ $V_R=400\text{V}$ , $I_F=30\text{A}$ , $di_F/dt=1000\text{A}/\mu\text{s}$ ,	-	139	-	ns
Reverse recovery charge	$Q_{rr}$		-	1160	-	nC
Reverse recovery	$I_{rrm}$		-	16.8	-	A
Reverse recovery energy	$E_{rr}$		-	167	-	$\mu\text{J}$

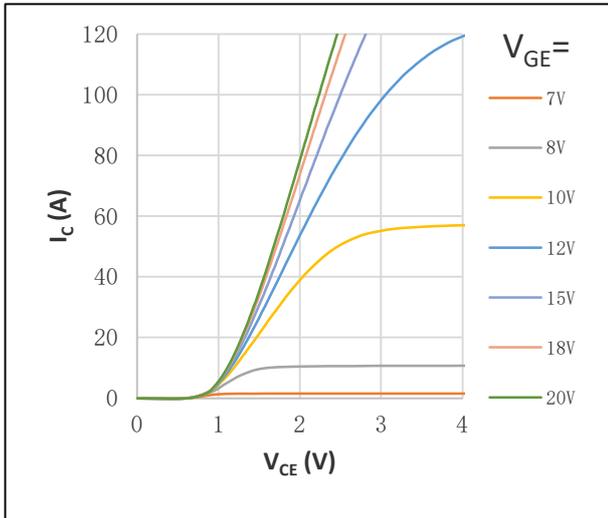
● Fig.1 Gate-emitter voltage as a function of gate charge; Typical values;  $T_j=25^\circ\text{C}$



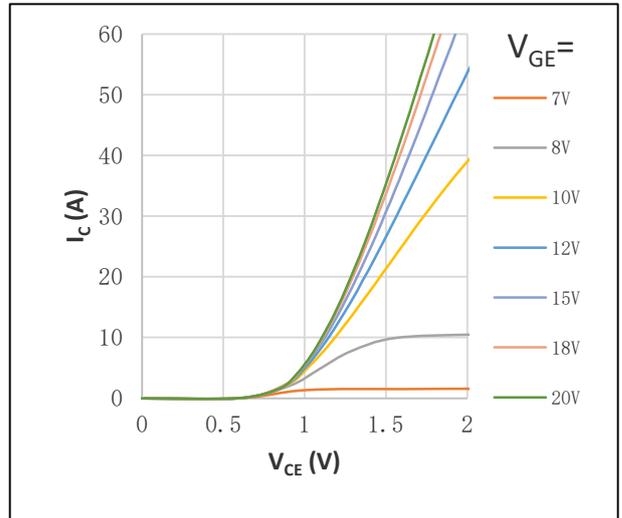
● Fig.2 Input, output and reverse transfer capacitances as a function of collector-emitter voltage; Typical values;  $T_j=25^\circ\text{C}$



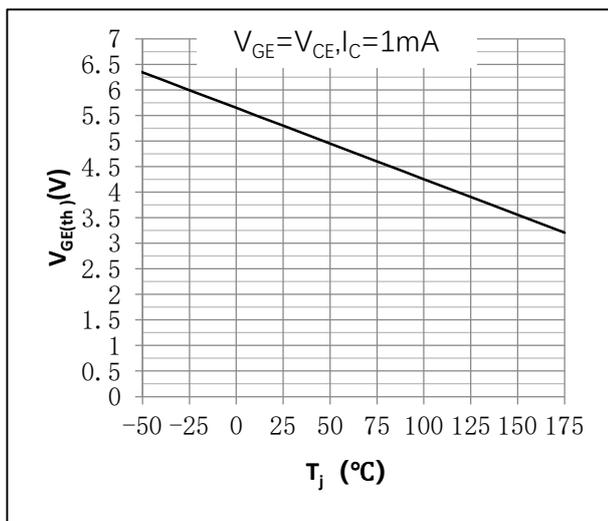
● Fig.3 Output characteristics: collector current as a function of collector-emitter voltage; Typical values;  $T_j=25^\circ\text{C}$



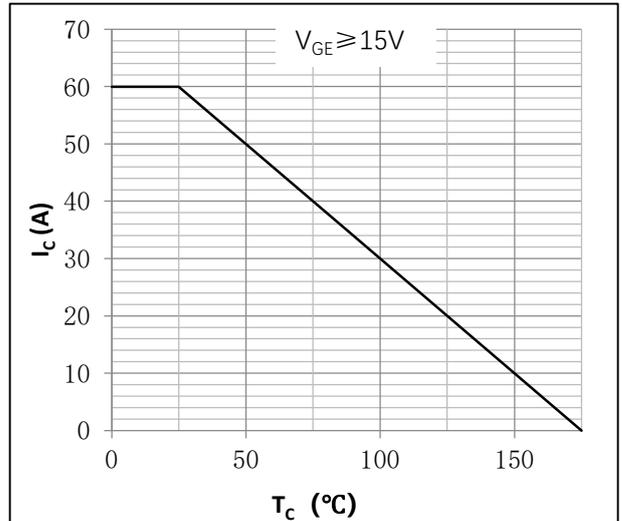
● Fig.4 Output characteristics: collector current as a function of collector-emitter voltage; Typical values: Expanded curve;  $T_j=25^\circ\text{C}$



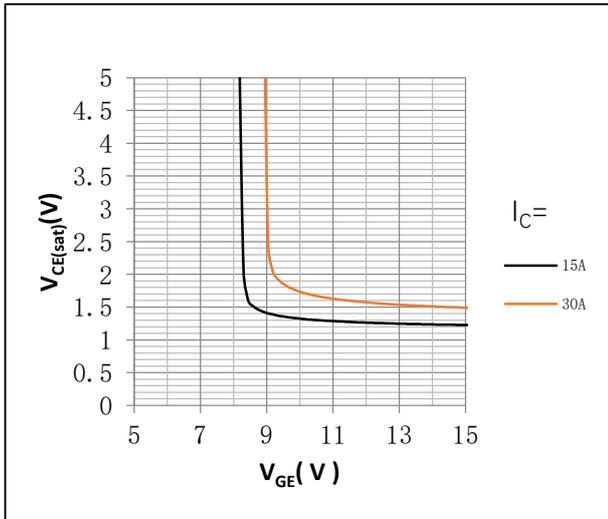
● Fig.5 Gate-emitter threshold voltage as a function of junction temperature; Typical values



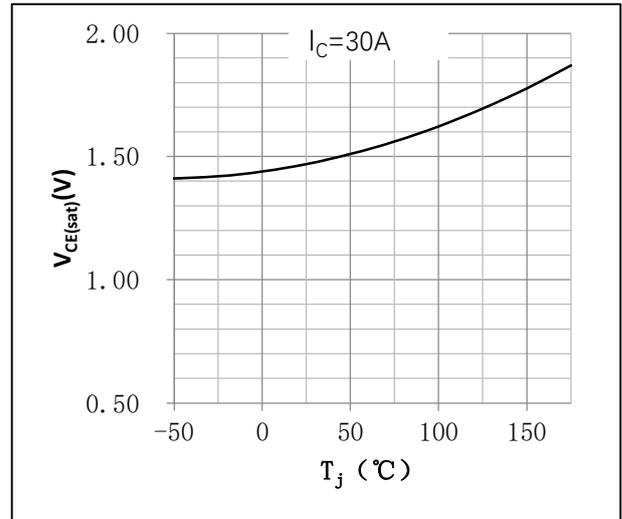
● Fig.6 Continuous collector current as a function of case temperature; Calculative values



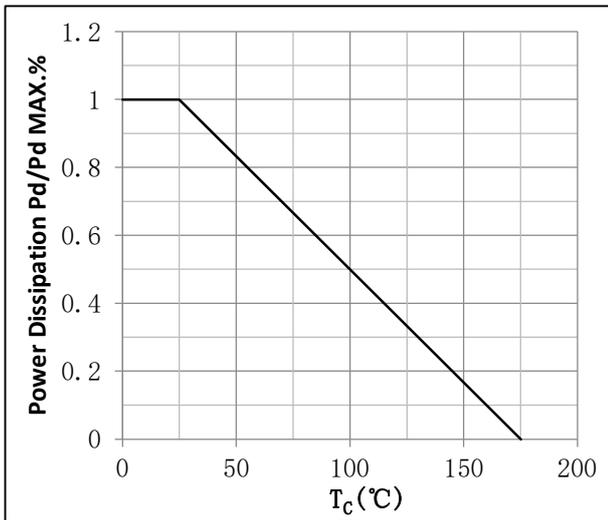
● Fig.7 Collector-emitter saturation voltage as a function of gate-emitter voltage; Typical values



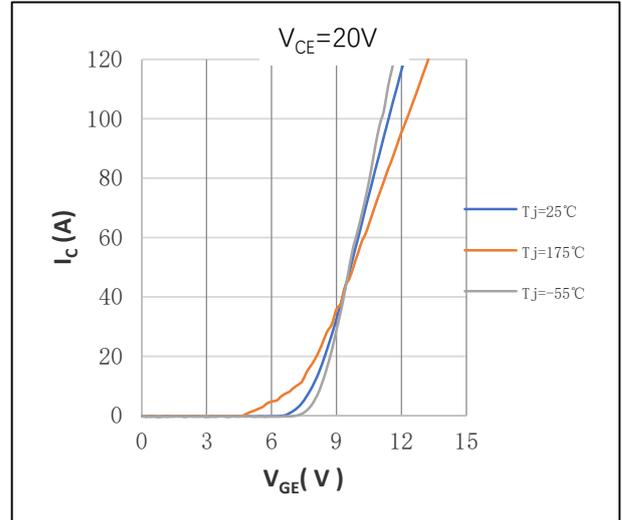
● Fig.8 Fig.6 Collector-emitter saturation voltage as a function of junction temperature; Typical values;  $T_j=25^\circ C$



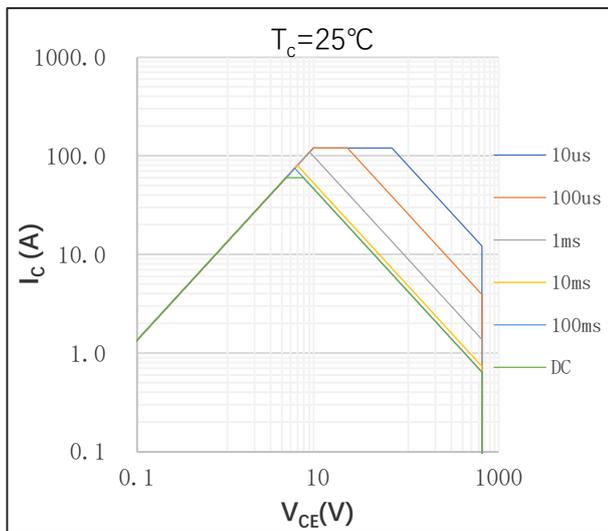
● Figure 9. Normalized total power dissipation as a function of case temperature; Calculative values Normalized Power Dissipation =  $P_d/P_d(25^\circ C)$



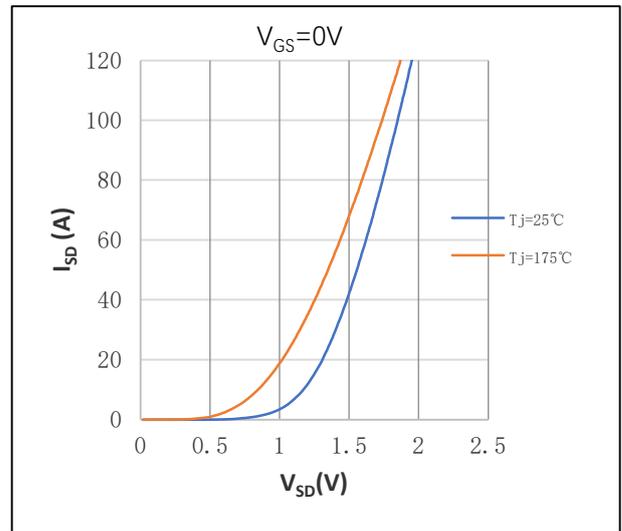
● Figure 10. Transfer characteristics: Collector current as a function of gate-emitter voltage; Typical values



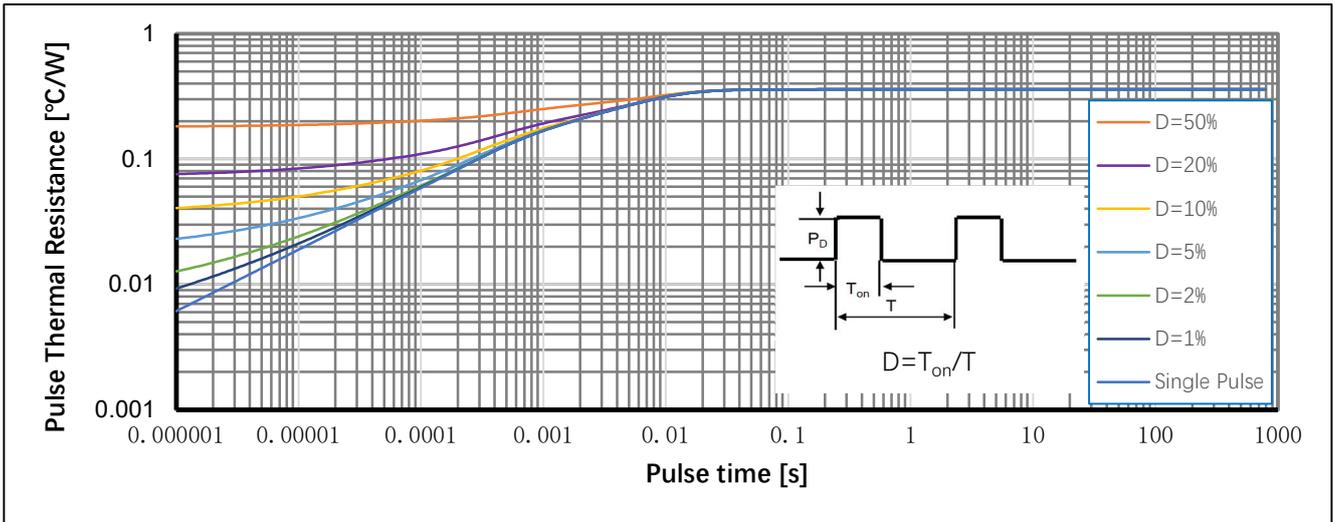
● Fig.11 Safe operating area: continuous and peak collector currents as a function of collector-emitter voltage; Calculative values



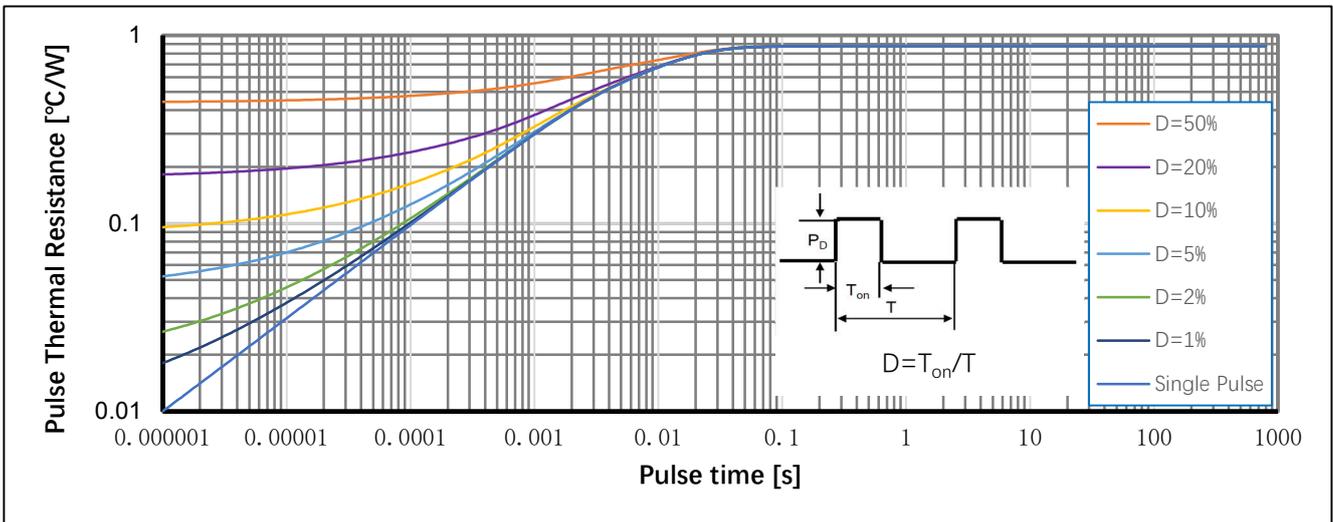
● Fig.12 Source (diode forward) current as a function of source-drain (diode forward) voltage; Typical values



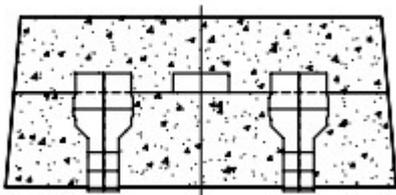
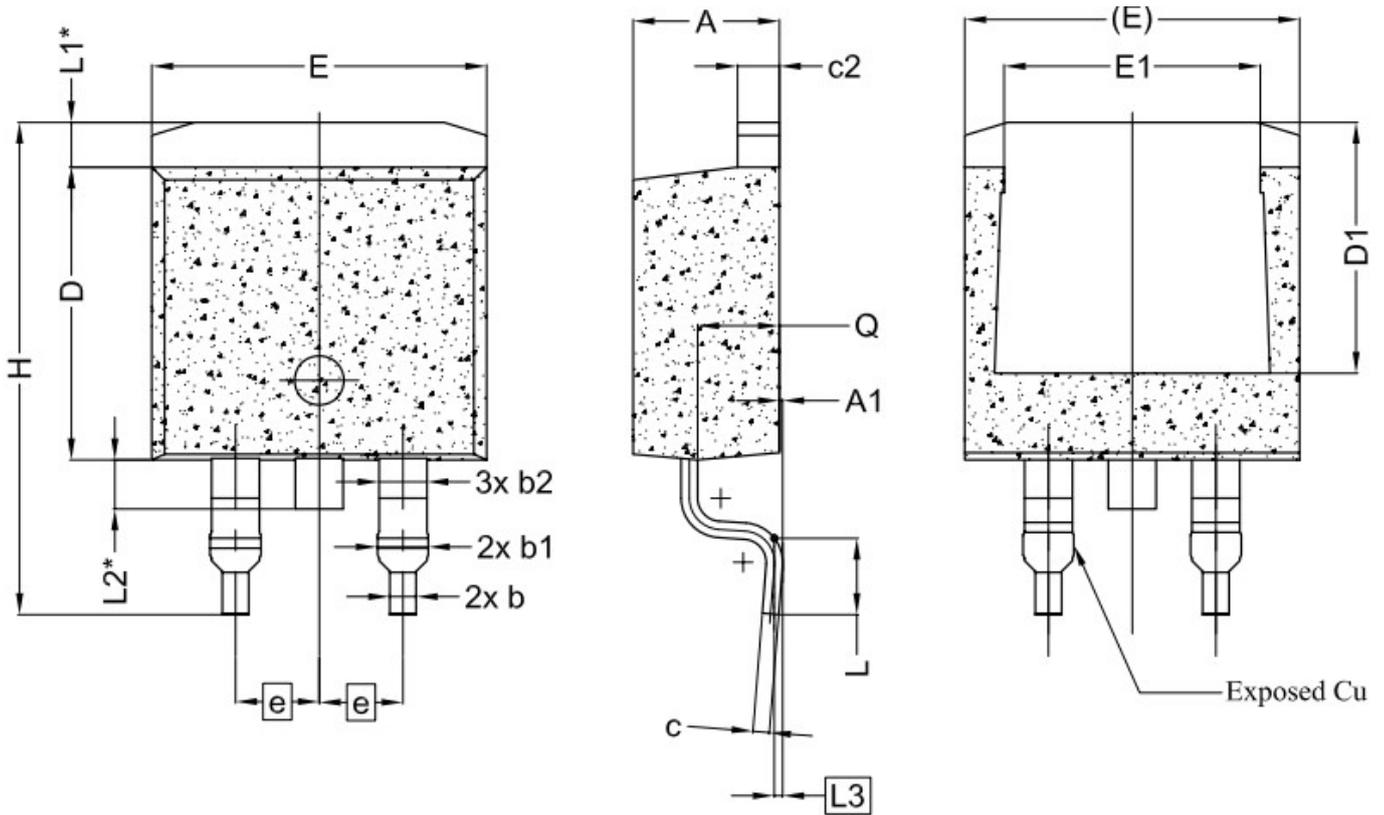
● Fig.13 Transient thermal impedance from junction to case -IGBT as a function of pulse duration; max values



● Fig.14 Transient thermal impedance from junction to case -diode as a function of pulse duration; max values



## ● Package Outline



SYMBOL	DIMENSIONS		
	MIN.	NOM.	MAX.
A	4.24	4.44	4.64
A1	0.00	0.10	0.25
b	0.70	0.80	0.90
b1	1.20	1.55	1.75
b2	1.20	1.45	1.70
c	0.40	0.50	0.60
c2	1.15	1.27	1.40
D	8.82	8.92	9.02
D1	6.86	7.65	--
E	9.96	10.16	10.36
E1	6.89	7.77	7.89
e	2.54 BSC		
H	14.61	15.00	15.88
L	1.78	2.32	2.79
L1	1.36 REF.		
L2	1.50 REF.		
L3	0.25 BSC		
Q	2.30	2.48	2.70

## ● Note

- ① Pulse :  $V_{GE}=+20V/-20V$ , Duty cycle=50%,  $T_j=175^{\circ}C$ ,  $t=1000$  hours; For DC , the following test conditions can be passed:  $V_{GE}=+20V/-10V$ ,  $T_j=175^{\circ}C$ ,  $t=1000$  hours;
- ② Device mounted on FR-4 substrate PC board, 2oz copper, with thermal bias to bottom layer 1inch square copper plate;
- ③ Practically the current will be limited by PCB, thermal design and operating temperature.  $V_{GE}=15V$ .

## ● Disclaimer

- Reproducing and modifying information of the document is prohibited without permission from ZMJ SEMICONDDUCTORS CO., LTD.
- ZMJ SEMICONDDUCTORS CO., LTD. reserves the rights to make changes of the content herein the document anytime without notification. Please refer to our website for the latest document.
- ZMJ SEMICONDDUCTORS CO., LTD. disclaims any and all liability arising out of the application or use of any product including damages incidentally and consequentially occurred.
- ZMJ SEMICONDDUCTORS CO., LTD. does not assume any and all implied warranties, including warranties of fitness for particular purpose, non-infringement and merchantability.
- Applications shown on the herein document are examples of standard use and operation. Customers are responsible in comprehending the suitable use in particular applications. ZMJ SEMICONDDUCTORS CO., LTD. makes no representation or warranty that such applications will be suitable for the specified use without further testing or modification.
- The products shown herein are not designed and authorized for equipments relating to human life and for any applications concerning life-saving or life-sustaining, such as medical instruments, aerospace machinery et cetera. Customers using or selling these products for use in such applications do so at their own risk and agree to fully indemnify ZMJ SEMICONDDUCTORS CO., LTD. for any damages resulting from such improper use or sale.
- Since ZMJ uses lot number as the tracking base, please provide the lot number for tracking when complaining.

## ● Revision History

Version	Date	Change
A	2025/6/30	New